Electronic Patent Application Fee Transmittal							
Application Number:	10560405						
Filing Date:	12-Dec-2005						
Timig Date.	12-Dec-2005						
Title of Invention:	Method of bonding microstructured substrates						
First Named Inventor/Applicant Name:	Isabelle Chartier						
Filer:	Suvashis Bhattacharya/Monica Pizarro						
Attorney Docket Number:	434299-678						
Filed as Large Entity	•						
U.S. National Stage under 35 USC 371 Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Notice of appeal		1401	1	540	540		
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 3 months with \$0 paid	1253	1	1110	1110
Miscellaneous:				
	Tot	1650		